



## DATE 2010 Friday Workshop

### 6th IEEE International Workshop on Silicon Debug and Diagnosis

March 12<sup>th</sup>, 2010 – Dresden, Germany



#### General Chair

B. Vermeulen – NXP Semiconductors

#### Program Co-chairs

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A. Crouch – ASSET Intertech

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#### European Liaison

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#### North-American Liaison

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#### University Liaison

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N. Nicolici – McMaster Univ.

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## Call for Papers

### Scope and Mission

Troubleshooting how and why systems and circuits fail is important and is rapidly growing in industry significance. Debug and diagnosis may be needed for yield improvement, process monitoring, correcting the design function, failure mode learning for R&D, or just getting a working first prototype. This detective work is however very tricky. Sources of difficulty include circuit and system complexity, packaging, limited physical access, shortened product creation cycle and time-to-market, the traditional focus on only pass/fail testing and missing tool and equipment capabilities. New and efficient solutions for debug and diagnosis have a much needed and highly visible impact on productivity.

### The topics of interest include, but are not limited to, the following:

- Debug Techniques and Methodologies
- Design and Synthesis for Debug
- DFT Reuse for Debug and Diagnosis
- Debug & Diagnosis Architectures
- Tools
- Debug Standardization
- SDD vs. Yield & TTM
- Case studies
- Microprocessor, FPGA, IP, SOC Debug
- Infrastructure IP for SDD
- System Level Debug & Diagnosis
- Manufacturing & Prototype Environment
- Equipment Impact and Techniques
- Cross-geography turn-on, debug & diagnosis issues
- Digital / Analog Turn-on

### Author Information

The workshop objective is to facilitate a valuable interactive information exchange. Contributions ranging from extended abstracts to full papers are acceptable for submission. Proposals that describe open issues, industry/technology needs or opinions are also welcome.

- Length Guideline: ranging from a one page, extended abstract up to 8 pages.
- Submissions due: **November 6<sup>th</sup>, 2009**
- Acceptance Notification: **November 20<sup>th</sup>, 2009**
- Final papers for inclusion into informal proceedings: **March 3<sup>rd</sup>, 2010**

Proposals for discussion panels and other special sessions are also invited. Please submit a one page abstract for these to the web site or contact the Program Co-chairs.

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### Submission & program information:

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For more information on SDD'10, visit the website at: <http://www.sdd-online.org>

